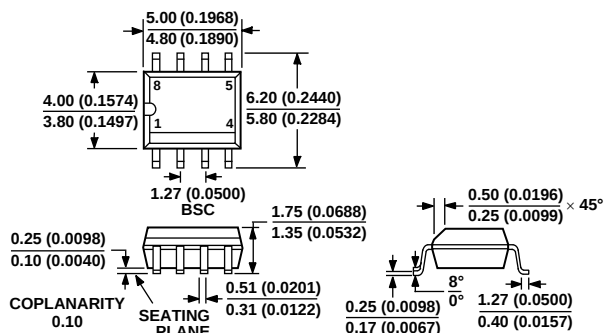


OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-012AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

Figure 70. 8-Lead Standard Small Outline Package [SOIC]
Narrow Body (R-8)—Dimensions shown in millimeters (inches)

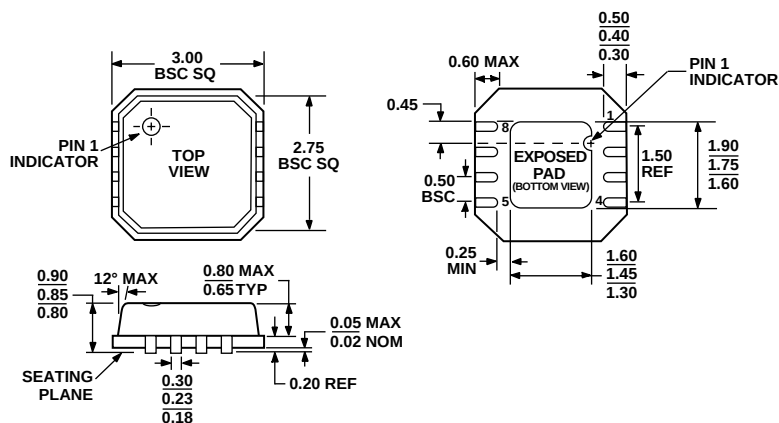


Figure 71. 8-Lead Lead Frame Chip Scale Package [LFCSP]
3 mm × 3 mm Body (CP-8-2)—Dimensions shown in millimeters

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option	Branding
AD8137YR	−40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	R-8	
AD8137YR-REEL	−40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	R-8	
AD8137YR-REEL7	−40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	R-8	
AD8137YRZ ¹	−40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	R-8	
AD8137YRZ-REEL ¹	−40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	R-8	
AD8137YRZ-REEL7 ¹	−40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	R-8	
AD8137YCP-R2	−40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSP)	CP-8-2	HFB
AD8137YCP-REEL	−40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSP)	CP-8-2	HFB
AD8137YCP-REEL7	−40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSP)	CP-8-2	HFB
AD8137YCPZ-R2 ¹	−40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSP)	CP-8-2	HGB
AD8137YCPZ-REEL ¹	−40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSP)	CP-8-2	HGB
AD8137YCPZ-REEL7 ¹	−40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSP)	CP-8-2	HGB

¹ Z = Pb-free part.